74LVC1G86-Q100

2-input EXCLUSIVE-OR gate Rev. 1 — 15 November 2013

Product data sheet

General description 1.

The 74LVC1G86-Q100 provides the 2-input EXCLUSIVE-OR function.

Inputs can be driven from either 3.3 V or 5 V devices. These features allow the use of these devices in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial Power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- ± 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options



3. Ordering information

Table 1. Ordering information									
Type number	Package	ickage							
	Temperature range	Name	Description	Version					
74LVC1G86GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1					
74LVC1G86GV-Q100	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753					

4. Marking

Table 2.Marking codes

Type number	Marking ^[1]
74LVC1G86GW-Q100	VH
74LVC1G86GV-Q100	V86

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

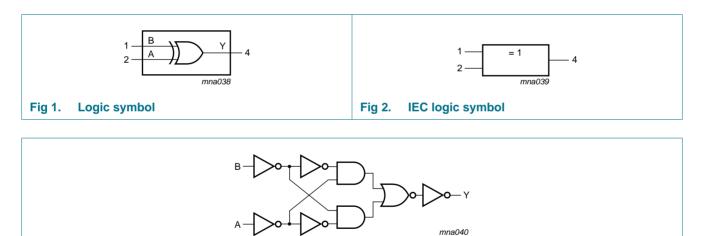
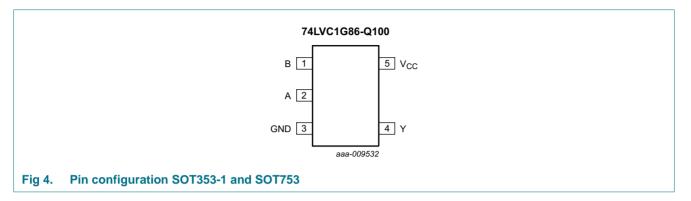


Fig 3. Logic diagram

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
В	1	data input
A	2	data input
GND	3	ground (0 V)
Y	4	data output
V _{CC}	5	supply voltage

7. Functional description

Table 4. Function ta	ble[<u>1]</u>	
Input		Output
Α	В	Y
L	L	L
L	Н	Н
Н	L	Н
Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	Active mode	<u>[1][2]</u> –0.5	V _{CC} + 0.5	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3]	250	mW
T _{stg}	storage temperature		-65	+150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

	1 0					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V _{CC}	V
		V _{CC} = 0 V; Power-down mode	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
		V_{CC} = 2.7 V to 5.5 V	-	-	10	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +8	5 °C	–40 °C to	• +125 °C	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max		
V _{IH}	HIGH-level	V _{CC} = 1.65 V to 1.95 V	$0.65V_{CC}$	-	-	0.65V _{CC}	-	V	
	input voltage	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V	
		V_{CC} = 4.5 V to 5.5 V	$0.7V_{CC}$	-	-	$0.7V_{CC}$	-	V	
V _{IL} LOW-level inp	LOW-level input	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	$0.35V_{CC}$	-	$0.35V_{CC}$	V	
	voltage	V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
		V_{CC} = 4.5 V to 5.5 V	-	-	$0.3V_{CC}$	-	$0.3V_{CC}$	V	
V _{он}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
output vol	output voltage	I _O = −100 μA; V _{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	$V_{CC}-0.1$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	0.95	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	1.7	-	V	
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	1.9	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	-	-	2.0	-	V	
		I_{O} = -32 mA; V_{CC} = 4.5 V	3.8	-	-	3.4	-	V	
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$							
		I _O = 100 μA; V _{CC} = 1.65 V to 5.5 V	-	-	0.10	-	0.10	V	
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.70	V	
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.30	-	0.45	V	
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.40	-	0.60	V	
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.80	V	
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.55	-	0.80	V	
I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	±0.1	±5	-	±100	μA	
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V_O = 5.5 V	-	±0.1	±10	-	±200	μA	
сс	supply current	$V_{I} = 5.5 V \text{ or GND}; I_{O} = 0 A;$ $V_{CC} = 1.65 V \text{ to } 5.5 V$	-	0.1	10	-	200	μA	
∆l _{CC}	additional supply current	per pin; V _{CC} = 2.3 V to 5.5 V; V _I = V _{CC} – 0.6 V; I _O = 0 A	-	5	500	-	5000	μA	
CI	input capacitance	V_{CC} = 3.3 V; V_{I} = GND to V_{CC}	-	5	-	-	-	рF	

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit, see Figure 6.

Symbol	Parameter	Conditions		–40 °C to +85 °C			-40 °C to	–40 °C to +125 °C	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	A, B to Y; see Figure 5	[2]						
	V_{CC} = 1.65 V to 1.95 V		1.0	3.7	9.9	1.0	13.0	ns	
		V_{CC} = 2.3 V to 2.7 V		0.5	2.5	5.5	0.5	7.0	ns
		$V_{CC} = 2.7 V$		0.5	2.8	5.8	0.5	7.5	ns
		V_{CC} = 3.0 V to 3.6 V		0.5	2.3	5.0	0.5	6.5	ns
		V_{CC} = 4.5 V to 5.5 V		0.5	1.9	4.0	0.5	5.5	ns
C _{PD}	power dissipation	$V_I = GND$ to V_{CC}	[3]						
	capacitance	$V_{CC} = 3.3 V$		-	25	-	-	-	pF

[1] All typical values are measured at nominal $V_{\mbox{CC}}.$

[2] t_{pd} is the same as t_{PLH} and t_{PHL}

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

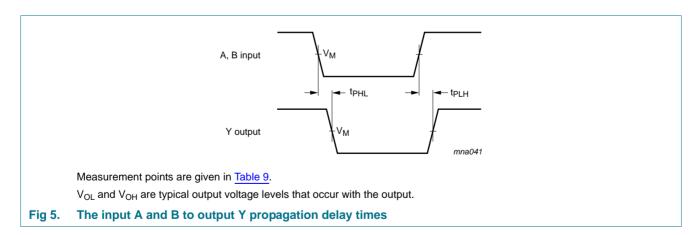
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

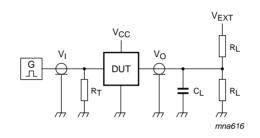
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12. Waveforms



Supply voltage	Input	Output					
V _{cc}	V _M	V _M					
1.65 V to 1.95 V	0.5V _{CC}	0.5V _{CC}					
2.3 V to 2.7 V	0.5V _{CC}	0.5V _{CC}					
2.7 V	1.5 V	1.5 V					
3.0 V to 3.6 V	1.5 V	1.5 V					
4.5 V to 5.5 V	0.5V _{CC}	0.5V _{CC}					

Table 9.Measurement points



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 6. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input	Input		Load		
V _{CC}	VI	$t_r = t_f$	CL	RL	t _{PLH} , t _{PHL}	
1.65 V to 1.95 V	V _{CC}	\leq 2.0 ns	30 pF	1 kΩ	open	
2.3 V to 2.7 V	V _{CC}	\leq 2.0 ns	30 pF	500 Ω	open	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	
4.5 V to 5.5 V	V _{CC}	\leq 2.5 ns	50 pF	500 Ω	open	

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13. Package outline

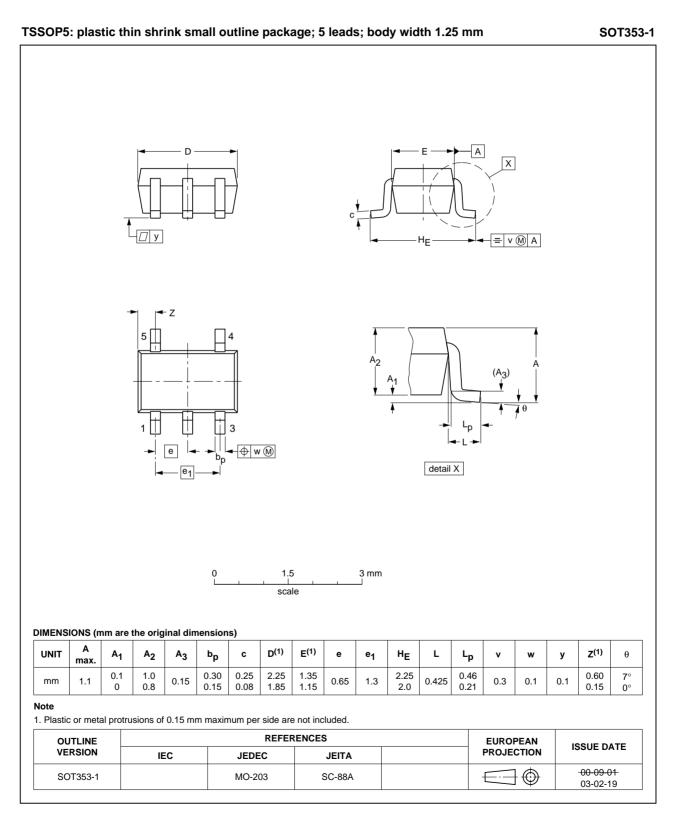
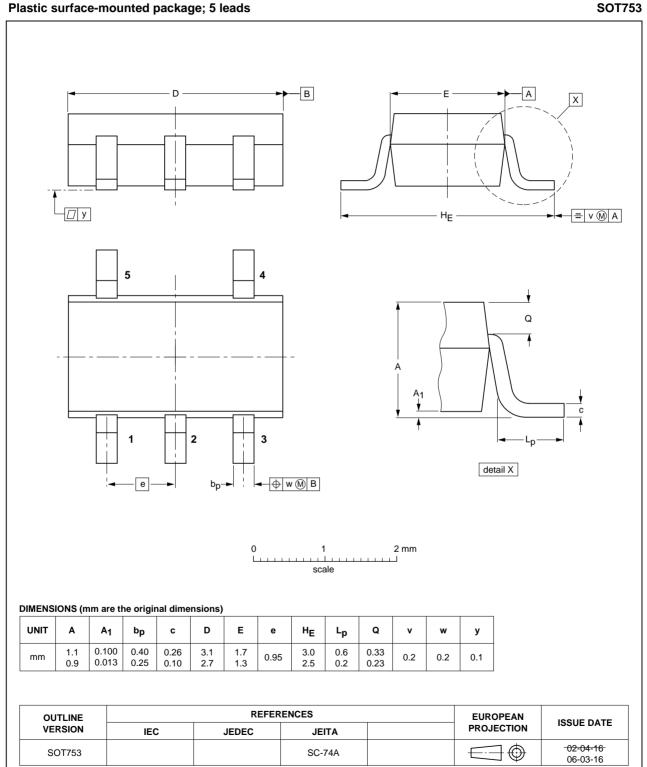


Fig 7. Package outline SOT353-1 (TSSOP5)

74LVC1G86_Q100



Plastic surface-mounted package; 5 leads

Package outline SOT753 (SC-74A) Fig 8.

74LVC1G86_Q100

14. Abbreviations

Table 11. Abbreviations					
Acronym	Description				
CMOS	Complementary Metal Oxide Semiconductor				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
HBM	Human Body Model				
MM	Machine Model				
TTL	Transistor-Transistor Logic				

15. Revision history

Table 12. Revision history								
Document ID	Release date	Data sheet status	Change notice	Supersedes				
74LVC1G86_Q100 v.1	20131115	Product data sheet	-	-				

16. Legal information

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Document status[1][2]	Product status ^[3]	Definition
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2-input EXCLUSIVE-OR gate

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Product data sheet

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